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CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.5)				Docket No.
Applicant(s): Allen et al.			BU	R920010150US1
Serial No.	Filing Date	Examiner	01/09/03	Group Art Unit
10/064,098	June 11, 2002	Unkn wh		2122
Invention: METHOD FO	OR IMPROVING CHIP YIELDS	S IN THE PRESENCE OF	VIA FLARIN	OIPE
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I hereby certify that this	Submission of Formal Drawin	ngs		
		(Identify type of correspondence	•	
is being deposited with	the United States Postal Sen	vice as first class mail in	an envelope a	ddressed to: The
Assistant Commissione	er for Patents, Washington, D.C	. 20231 on Oct	ober 22, 2002	
			(Date)	
			W. Gibb, III	
		(Typed or Printed Name of Pe	erson Mailing Corre	spondence)
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		(Signature of Person M	failing Corresponde	ence)

Note: Each paper must have its own certificate of mailing.





In re Application of

Allen et al.

Serial No.: 10/064,098

Group Art Unit: 2122

Filed: June 11, 2002

Examiner: Unknown

For:

METHOD FOR IMPROVING CHIP YIELDS IN THE PRESENCE OF VIA FLARING

Assistant Commissioner of Patents Washington, D.C. 20231

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SUBMISSION OF FORMAL DRAWINGSechnology Center 2100

Sir:

Submitted herewith are eight (8) sheets of formal drawings comprising Figs. 1A-8 for the above-referenced patent application. Acknowledgment of receipt is respectfully requested. Please substitute these formal drawings for the drawings which were filed with the application.

Respectfully Submitted,

Frederick W. Gibb, III

Reg. No. 37,629

Date: 10/22/02

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